



2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power-Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low-Voltage, High-Frequency Inverters,
 Free-Wheeling, and Polarity Protection Application
- High-Temperature Soldering: +260°C/10 Second at Terminal
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 63
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (Approximate)
 SMB 0.093 grams (Approximate)

SMA/SMB





Top View

Bottom View

Ordering Information (Note 4)

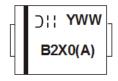
| Part Number | Qualification | Case | Packaging |
|-------------|---------------|------|-------------------|
| B2xxA-13-F | Standard | SMA | 5,000/Tape & Reel |
| B2xx-13-F | Standard | SMB | 3,000/Tape & Reel |
| B250Q-13 | Automotive | SMB | 3,000/Tape & Reel |
| B240AQ-13-F | Automotive | SMA | 5,000/Tape & Reel |
| B240Q-13-F | Automotive | SMB | 3,000/Tape & Reel |

^{*} x = Device type, e.g. B260A-13-F (SMA package); B240-13-F (SMB package).

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- 5. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

Marking Information



B2X0A = Product type marking code, ex: B220A (SMA package)
B2X0 = Product type marking code, ex: B230 (SMB package)

) | | = Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year (ex: 5 for 2015)
WW = Week code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

| Characteristic | Symbol | B220/A | B230/A | B240/A | B250/A | B260/A | Unit |
|--|--|--------|--------|--------|--------|--------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 20 | 30 | 40 | 50 | 60 | V |
| RMS Reverse Voltage | V _{R(RMS)} | 14 | 21 | 28 | 35 | 42 | V |
| Average Rectified Output Current | Io | | | 2.0 | | | Α |
| Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load | | 50 | | | | А | |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit | |
|--|--------|-----------------------------------|-------------|------|
| Typical Thermal Resistance, Junction to Lead SMA SMB | | $R_{	heta JL}$ | 25 20 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -65 to +150 | °C |

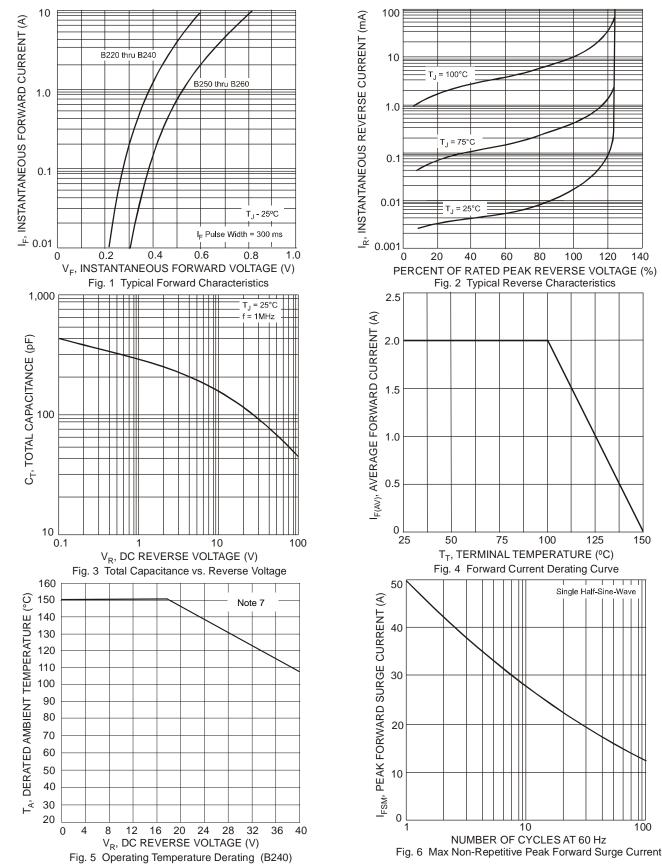
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Min | Тур | Max | Unit | Test Condition |
|--------------------------|--|----------------|-----|-----|--------------|------|---|
| Forward Voltage Drop | B220/A, B230/A, B240/A B250/A, B260/A | \/- | _ | _ | 0.50 0.70 | V | I _F = 2.0A, T _A = +25°C |
| Leakage Current (Note 6) | | I _R | | _ | 0.5 20 | mA | @ Rated V_R , $T_A = +25$ °C @ Rated V_R , $T_A = +100$ °C |
| Total Capacitance | | C _T | | _ | 200 | pF | $V_R = 40V, f = 1MHz$ |

Note: 6. Short duration pulse test used to minimize self-heating effect.

July 2015





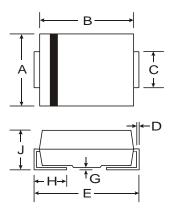
7. Device mounted on FR-4 PC board with minimum recommended pad layout pattern as per http://www.diodes.com. Note:



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

SMA/SMB



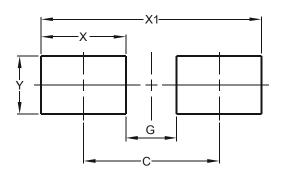
| SMA | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 2.29 | 2.92 | | |
| В | 4.00 | 4.60 | | |
| С | 1.27 | 1.63 | | |
| D | 0.15 | 0.31 | | |
| Е | 4.80 | 5.59 | | |
| G | 0.05 | 0.20 | | |
| Н | 0.76 | 1.52 | | |
| J | 2.01 | 2.30 | | |
| All Dimensions in mm | | | | |

| SMB | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 3.30 | 3.94 | | |
| В | 4.06 | 4.57 | | |
| С | 1.96 | 2.21 | | |
| D | 0.15 | 0.31 | | |
| E | 5.00 | 5.59 | | |
| G | 0.05 | 0.20 | | |
| Н | 0.76 | 1.52 | | |
| J | 2.00 | 2.50 | | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.

SMA/SMB



| SMA | | | |
|-------------------------|------|--|--|
| Dimensions Value (in mi | | | |
| С | 4.00 | | |
| G | 1.50 | | |
| Х | 2.50 | | |
| X1 | 6.50 | | |
| Υ | 1.70 | | |

| SMB | | | |
|------------|---------------|--|--|
| Dimensions | Value (in mm) | | |
| С | 4.30 | | |
| G | 1.80 | | |
| Х | 2.50 | | |
| X1 | 6.80 | | |
| Υ | 2.30 | | |

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